

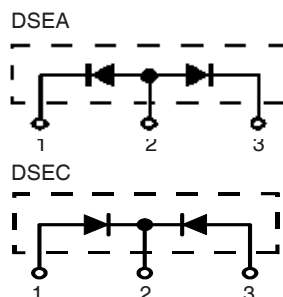
HiPerDynFRED™ Epitaxial Diode

ISOPLUS220™

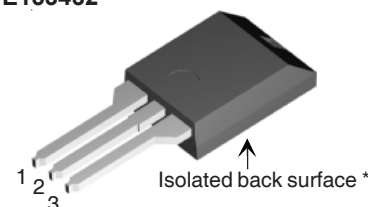
Electrically Isolated Back Surface

Preliminary Data Sheet

V_{RSM} V	V_{RRM} V	Type
600	600	DSEA29-06AC
600	600	DSEC 29-06AC



ISOPLUS220™
E153432



Symbol	Conditions	Maximum Ratings	
I_{FRMS}		35	A
I_{FAVM}	$T_C = 140^\circ\text{C}$; rectangular, $d = 0.5$	15	A
I_{FSM}	$T_{VJ} = 45^\circ\text{C}$; $t_p = 10$ ms (50 Hz), sine	110	A
E_{AS}	$T_{VJ} = 25^\circ\text{C}$; non-repetitive $I_{AS} = 0.9$ A; $L = 180$ μH	0.1	mJ
I_{AR}	$V_A = 1.5 \cdot V_R$ typ.; $f = 10$ kHz; repetitive	0.1	A
T_{VJ}		-55...+175	$^\circ\text{C}$
T_{VJM}		175	$^\circ\text{C}$
T_{stg}		-55...+150	$^\circ\text{C}$
P_{tot}	$T_C = 25^\circ\text{C}$	95	W
V_{ISOL}	50/60 Hz RMS; $I_{ISOL} \leq 1$ mA	2500	V~
F_C	mounting force with clip	11...65 / 2.5...15	N / lb
Weight	typical	3	g

Features

- ▮ Silicon chip on Direct-Copper-Bond substrate
- ▮ High power dissipation
- ▮ Isolated mounting surface
- ▮ 2500V electrical isolation
- ▮ Low cathode to tab capacitance (<15pF)
- ▮ Planar passivated chips
- ▮ Very short recovery time
- ▮ Extremely low switching losses
- ▮ Low I_{RM} -values
- ▮ Soft recovery behaviour
- ▮ Epoxy meets UL 94V-0

Applications

- ▮ Antiparallel diode for high frequency switching devices
- ▮ Antisaturation diode
- ▮ Snubber diode
- ▮ Free wheeling diode in converters and motor control circuits
- ▮ Rectifiers in switch mode power supplies (SMPS)
- ▮ Inductive heating
- ▮ Uninterruptible power supplies (UPS)
- ▮ Ultrasonic cleaners and welders

Advantages

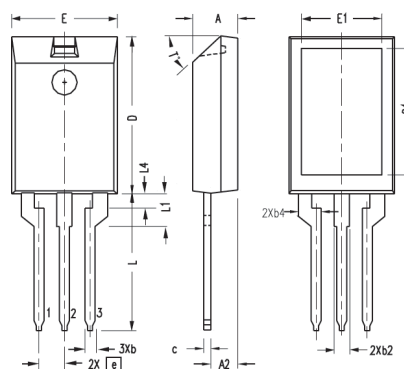
- ▮ Avalanche voltage rated for reliable operation
- ▮ Soft reverse recovery for low EMI/RFI
- ▮ Low I_{RM} reduces:
 - Power dissipation within the diode
 - Turn-on loss in the commutating switch

Symbol	Conditions	Characteristic Values	
		typ.	max.
I_R ①	$T_{VJ} = 25^\circ\text{C}$ $V_R = V_{RRM}$ $T_{VJ} = 150^\circ\text{C}$ $V_R = V_{RRM}$		100 μA 0.5 mA
V_F ②	$I_F = 15$ A; $T_{VJ} = 150^\circ\text{C}$ $T_{VJ} = 25^\circ\text{C}$		1.34 V 2.03 V
R_{thJC} R_{thCH}		0.6	1.6 K/W K/W
t_{rr}	$I_F = 1$ A; $-di/dt = 50$ A/ μs ; $V_R = 30$ V; $T_{VJ} = 25^\circ\text{C}$	35	ns
I_{RM}	$V_R = 100$ V; $I_F = 25$ A; $-di_F/dt = 100$ A/ μs $T_{VJ} = 100^\circ\text{C}$	4	4.9 A

Notes: Data given for $T_{VJ} = 25^\circ\text{C}$ and per diode unless otherwise specified
 See DSEC 29-06A for electrical characteristic curves
 ② Pulse test: pulse Width = 5 ms, Duty Cycle < 2.0 %
 ③ Pulse test: pulse Width = 300 μs , Duty Cycle < 2.0 %

IXYS reserves the right to change limits, test conditions and dimensions.

98829 (5/05)

ISOPLUS220 OUTLINE


SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.157	.197	4.00	5.00
A2	.098	.118	2.50	3.00
b	.035	.051	0.90	1.30
b2	.049	.065	1.25	1.65
b4	.093	.100	2.35	2.55
c	.028	.039	0.70	1.00
D	.591	.630	15.00	16.00
D1	.472	.512	12.00	13.00
E	.394	.433	10.00	11.00
E1	.295	.335	7.50	8.50
e	.100 BASIC		2.55 BASIC	
L	.512	.571	13.00	14.50
L1	.118	.138	3.00	3.50
L4	.039	.059	1.00	1.50
T*			42.5°	47.5°

Note: All terminals are solder plated.

DSEA: 1 - Cathode
 2 - Anode
 3 - Cathode

DSEC: 1 - Anode
 2 - Cathode
 3 - Anode